

PATENT



IBM/145DV1  
Confirmation No. 3332

2841 84  
02-14-02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Mark Kenneth Hoffmeyer et al. Art Unit: 2841  
Serial No.: 09/924,711 Examiner: Unknown  
Filed: August 8, 2001 Atty. Docket No.: IBM/145DV1  
For: PROCESSING OF CIRCUIT BOARDS WITH PROTECTIVE, ADHESIVE-LESS  
COVERS ON AREA ARRAY BONDING SITES

TRANSMITTAL

Assistant Commissioner for Patents  
Washington, DC 20231

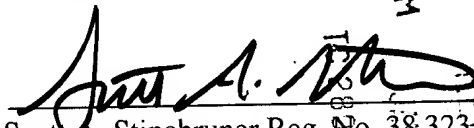
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Supplemental Information Disclosure Statement  
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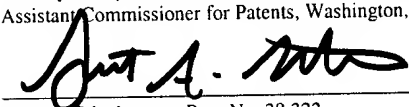
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By:   
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